

### Z-PACK | Z-PACK HM-eZd+

TE Internal #: 2170902-1

High Speed Backplane Connectors, Board-to-Board, 80 Position, Mating Alignment, Polarization Mating Alignment Type, 8 Row, 10 Column, Z-PACK HM-eZd+

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Connectors > PCB Connectors > Backplane Connectors > High Speed Connectors



Connector System: Board-to-Board

Number of Positions: 80

Row-to-Row Spacing: 4.5 mm [ .177 in ]

Mating Alignment: With

Mating Alignment Type: Polarization

### **Features**

## **Product Type Features**

Signal Arrangement	Differential
Connector System	Board-to-Board
PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Unshrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Pairs per Column	4
Card Slot Centerline	25.4 mm
Number of Positions	80
Number of Rows	8
Number of Columns	10
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	42 VAC
Contact Features	

4.3 mm[.169 in]

Contact Mating Area Length



	F 2 F[20 100 1.]
PCB Contact Termination Area Plating Material Thickness	.5 – 2.5 μm[20 – 100 μin]
Contact Type	Pin 77
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Mating Area Plating Material	Gold
PCB Contact Termination Area Plating Material Finish	Matte
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	.5 A
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Mechanical Attachment	
Mating Alignment	With
Mating Alignment Type	Polarization
Connector Mounting Type	Board Mount
Housing Features	
Number of Shrouded Sides	0
Housing Material	LCP (Liquid Crystal Polymer)
Housing Color	Black
Centerline (Pitch)	2.5 mm[.098 in]
Dimensions	
PCB Hole Diameter	.36 mm
Row-to-Row Spacing	4.5 mm[.177 in]
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
Durability Rating	200 Cycles
Shielded	Yes
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Box & Tube



## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

#### Product Compliance Disclaimer

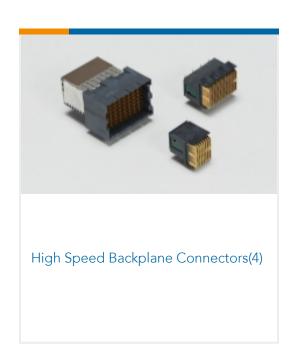
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**



Also in the Series | Z-PACK HM-eZd+





# Customers Also Bought



TE Part #5787082-9 100 50SR R/A RCP ASSY,RDSN L/F



TE Part #390111-1 SKT,SODIMM,144P,SGRAM3.3V,HIGH, TY-S



TE Part #3-1939756-6 .5FHP08H,220,S,GIG,30/Sn,HT,NS



EMBOSS TAPE DDR3 204P 4H RVS



TE Part #2-2013311-1 EMBOSS TAPE DDR3 204P 9.2H RVS



TE Part #2-2013298-1
EMBOSS TAPE DDR3 204P 8H RVS



TE Part #2227671-9
ZQSFP+ STACKED REC ASSEMBLY
2X3,4LP R UP



SW PIR/DPO RA ASSY 12P6C 100

OHM 90 GR





## **Documents**

## **Product Drawings**

HM-EZD+,4PAIRS,10COLS,VERTICAL,ASSEMBLY

English

## **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2170902-1\_A.2d\_dxf.zip

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English

**Customer View Model** 

ENG\_CVM\_CVM\_2170902-1\_A.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2170902-1\_A.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**Product Specifications** 

**Application Specification** 

English

**Product Environmental Compliance** 

**Product Compliance** 

English

**Product Compliance** 

English